

PACKAGING INFORMATION

| Status | Package Type | | Pins | - | Eco Plan | Lead finish/ | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|--------|---|---|--|--|---|--|---|--|--|---|
| (1) | | Drawing | | Qty | (2) | Ball material | (3) | | (4/5) | |
| | | | | | | (6) | | | | |
| ACTIVE | SM8 | DCT | 8 | 3000 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | (1NT, NG2) | Samples |
| | | | | | | | | | (S, Y) | |
| ACTIVE | VSSOP | DCU | 8 | 3000 | RoHS & Green | NIPDAU SN | Level-1-260C-UNLIM | -40 to 125 | (G2, NG2J, NG2P, N | Samples |
| | | | | | | | | | G2S) | T |
| | | | | | | | | | NY | |
| ACTIVE | SOT-23-THIN | DDF | 8 | 3000 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | F0102 | Samples |
| | | | | | | | | | | Samples |
| ACTIVE | X2SON | DQE | 8 | 5000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | RV | Samples |
| | | | | | | | | | | 1 |
| ACTIVE | DSBGA | YZT | 8 | 3000 | RoHS & Green | SNAGCU | Level-1-260C-UNLIM | -40 to 125 | RV | Samples |
| | (1) ACTIVE ACTIVE ACTIVE ACTIVE | (1)ACTIVESM8ACTIVEVSSOPACTIVESOT-23-THINACTIVEX2SON | (1)DrawingACTIVESM8DCTACTIVEVSSOPDCUACTIVESOT-23-THINDDFACTIVEX2SONDQE | (1)DrawingACTIVESM8DCT8ACTIVEVSSOPDCU8ACTIVESOT-23-THINDDF8ACTIVEX2SONDQE8 | (1)DrawingQtyACTIVESM8DCT83000ACTIVEVSSOPDCU83000ACTIVESOT-23-THINDDF83000ACTIVEX2SONDQE85000 | (1)DrawingQty(2)ACTIVESM8DCT83000RoHS & GreenACTIVEVSSOPDCU83000RoHS & GreenACTIVESOT-23-THINDDF83000RoHS & GreenACTIVEX2SONDQE85000RoHS & Green | (1)DrawingQty(2)Ball material (6)ACTIVESM8DCT83000RoHS & GreenSNACTIVEVSSOPDCU83000RoHS & GreenNIPDAU SNACTIVESOT-23-THINDDF83000RoHS & GreenSNACTIVEX2SONDQE85000RoHS & GreenNIPDAU | (1)DrawingQty(2)Ball material (6)(3)ACTIVESM8DCT83000RoHS & GreenSNLevel-1-260C-UNLIMACTIVEVSSOPDCU83000RoHS & GreenNIPDAU SNLevel-1-260C-UNLIMACTIVESOT-23-THINDDF83000RoHS & GreenSNLevel-1-260C-UNLIMACTIVEX2SONDQE85000RoHS & GreenNIPDAULevel-1-260C-UNLIM | (1)DrawingQty(2)Ball material (6)(3)ACTIVESM8DCT83000RoHS & GreenSNLevel-1-260C-UNLIM-40 to 125ACTIVEVSSOPDCU83000RoHS & GreenNIPDAU SNLevel-1-260C-UNLIM-40 to 125ACTIVESOT-23-THINDDF83000RoHS & GreenSNLevel-1-260C-UNLIM-40 to 125ACTIVEX2SONDQE85000RoHS & GreenNIPDAULevel-1-260C-UNLIM-40 to 125 | (1)DrawingQty(2)Ball material (6)(3)(3)(4)(4/5)ACTIVESM8DCT83000RoHS & GreenSNLevel-1-260C-UNLIM-40 to 125(1NT, NG2) (S, Y)ACTIVEVSSOPDCU83000RoHS & GreenNIPDAU SNLevel-1-260C-UNLIM-40 to 125(G2, NG2J, NG2P, N G2S) |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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OTHER QUALIFIED VERSIONS OF LSF0102 :

• Automotive : LSF0102-Q1

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects